

Title (en)

CONTROLLED COMPLIANCE FINE PITCH INTERCONNECT

Title (de)

FEINRASTERVERBINDUNG MIT KONTROLLIRTER NACHGIEBIGKEIT

Title (fr)

INTERCONNEXION A PAS FIN ET A CONFORMITE REGLEE

Publication

EP 1204988 A2 20020515 (EN)

Application

EP 00955283 A 20000731

Priority

- US 0020748 W 20000731
- US 14682599 P 19990802

Abstract (en)

[origin: WO0109980A2] A method and apparatus for achieving a very fine pitch interconnect between a flexible circuit member and another circuit member with extremely co-planar electrical contacts that have a large range of compliance. An electrical interconnect assembly that can be used as a die-level test probe, a wafer probe, and a printed circuit probe is also disclosed. The second circuit member can be a printed circuit board, another flexible circuit, a bare-die device, an integrated circuit device, an organic or inorganic substrate, a rigid circuit and virtually any other type of electrical component. A plurality of electrical contacts are arranged in a housing. The electrical contacts may be arranged randomly or in a one or two-dimensional array. The housing acts as a receptacle to individually locate and generally align the electrical contacts, while preventing adjacent contacts from touching. The first ends of the electrical contacts are electrically coupled to a flexible circuit member. The electrical contacts are free to move along a central axis within the housing. The second ends of the electrical contacts are free to electrically couple with one or more second circuit members without the use of solder.

IPC 1-7

H01L 21/66; G01R 1/067; G01R 1/073

IPC 8 full level

G01R 1/06 (2006.01); **G01R 1/067** (2006.01); **G01R 1/073** (2006.01); **G01R 31/02** (2006.01); **H01L 21/60** (2006.01); **H01L 21/66** (2006.01); **H05K 3/32** (2006.01); **H01R 12/52** (2011.01)

CPC (source: EP)

G01R 1/0735 (2013.01); **H05K 3/326** (2013.01); **G01R 1/06738** (2013.01); **H01R 12/523** (2013.01)

Citation (search report)

See references of WO 0109980A2

Designated contracting state (EPC)

AT BE CH CY DE DK ES FI FR GB GR IE IT LI LU MC NL PT SE

DOCDB simple family (publication)

WO 0109980 A2 20010208; **WO 0109980 A3 20010830**; AU 6750900 A 20010219; EP 1204988 A2 20020515; JP 2003506833 A 20030218

DOCDB simple family (application)

US 0020748 W 20000731; AU 6750900 A 20000731; EP 00955283 A 20000731; JP 2001514505 A 20000731